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January 2014



## FSB50550A / FSB50550AT Motion SPM<sup>®</sup> 5 Series

## Features

- UL Certified No. E209204 (UL1557)
- 500 V R<sub>DS(on)</sub> = 1.4 Ω(Max) FRFET MOSFET 3-Phase Inverter with Gate Drivers and Protection
- Built-In Bootstrap Diodes Simplify PCB Layout
- Separate Open-Source Pins from Low-Side MOSFETs for Three-Phase Current-Sensing
- Active-HIGH Interface, Works with 3.3 / 5 V Logic, Schmitt-trigger Input
- Optimized for Low Electromagnetic Interference
- HVIC Temperature-Sensing Built-In for Temperature Monitoring
- HVIC for Gate Driving and Under-Voltage Protection
- Isolation Rating: 1500 V<sub>rms</sub> / min.
- RoHS Compliant

## **Applications**

 3-Phase Inverter Driver for Small Power AC Motor Drives

## **Related Source**

- <u>RD-FSB50450A Reference Design for Motion SPM\_5</u> <u>Series Ver.2</u>
- <u>AN-9082 Motion SPM5 Series Thermal Performance</u> <u>by Contact Pressure</u>
- <u>AN-9080 User's Guide for Motion SPM 5 Series V2</u>

## **General Description**

The FSB50550A/AT is an advanced Motion SPM<sup>®</sup> 5 module providing a fully-featured, high-performance inverter output stage for AC Induction, BLDC and PMSM motors. These modules integrate optimized gate drive of the built-in MOSFETs (FRFET<sup>®</sup> technology) to minimize EMI and losses, while also providing multiple on-module protection features including under-voltage lockouts and The built-in thermal monitoring. high-speed HVIC requires only a single supply voltage and translates the incoming logic-level gate inputs to the high-voltage, high-current drive signals required to properly drive the module's internal MOSFETs. Separate open-source MOSFET terminals are available for each phase to support the widest variety of control algorithms.



FSB50550A

FSB50550AT

## Package Marking & Ordering Information

Device	Device Marking	Package	Packing Type	Quantity
FSB50550A	FSB50550A	SPM5P-023	Rail	15
FSB50550AT	FSB50550AT	SPM5N-023	Rail	15

## **Absolute Maximum Ratings**

Inverter Part (each MOSFET unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>DSS</sub>	Drain-Source Voltage of Each MOSFET		500	V
*I <sub>D 25</sub>	Each MOSFET Drain Current, Continuous	$T_{C} = 25^{\circ}C$	2.0	А
*I <sub>D 80</sub>	Each MOSFET Drain Current, Continuous	$T_{C} = 80^{\circ}C$	1.5	А
*I <sub>DP</sub>	Each MOSFET Drain Current, Peak	$T_{C} = 25^{\circ}C, PW < 100 \ \mu s$	5	A
*I <sub>DRMS</sub>	Each MOSFET Drain Current, Rms	$T_{C} = 80^{\circ}C, F_{PWM} < 20 \text{ kHz}$	1.1	A <sub>rms</sub>
*P <sub>D</sub>	Maximum Power Dissipation	$T_{C} = 25^{\circ}C$ , For Each MOSFET	14.5	W

## Control Part (each HVIC unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>CC</sub>	Control Supply Voltage	Applied between $V_{CC}$ and COM	20	V
V <sub>BS</sub>	High-side Bias Voltage	Applied between $\rm V_B$ and $\rm V_S$	20	V
V <sub>IN</sub>	Input Signal Voltage	Applied between V <sub>IN</sub> and COM	$-0.3 \sim V_{CC} + 0.3$	V

Bootstrap Diode Part (each bootstrap diode unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>RRMB</sub>	Maximum Repetitive Reverse Voltage		500	V
* I <sub>FB</sub>	Forward Current	$T_{C} = 25^{\circ}C$	0.5	А
* I <sub>FPB</sub>	Forward Current (Peak)	$T_{C} = 25^{\circ}C$ , Under 1ms Pulse Width	1.5	A

### Thermal Resistance

Symbol	Parameter	Conditions	Rating	Unit
$R_{ extsf{ heta}JC}$	Liunction to Case Thermal Resistance	Each MOSFET under Inverter Oper- ating Condition (1st Note 1)	8.6	°C/W

#### **Total System**

Symbol	Parameter	Conditions	Rating	Unit
Τ <sub>J</sub>	Operating Junction Temperature		-40 ~ 150	°C
T <sub>STG</sub>	Storage Temperature		-40 ~ 125	°C
V <sub>ISO</sub>	Isolation Voltage	60 Hz, Sinusoidal, 1 Minute, Con- nect Pins to Heat Sink Plate	1500	V <sub>rms</sub>

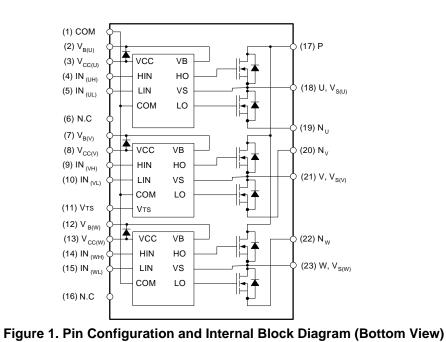
1st Notes:

1. For the measurement point of case temperature  $\mathsf{T}_{\mathsf{C}},$  please refer to Figure 4.

2. Marking "\*" is calculation value or design factor.

## **Pin descriptions**

Pin Number	Pin Name	Pin Description
1	СОМ	IC Common Supply Ground
2	V <sub>B(U)</sub>	Bias Voltage for U-Phase High-Side MOSFET Driving
3	V <sub>CC(U)</sub>	Bias Voltage for U-Phase IC and Low-Side MOSFET Driving
4	IN <sub>(UH)</sub>	Signal Input for U-Phase High-Side
5	IN <sub>(UL)</sub>	Signal Input for U-Phase Low-Side
6	N.C	No Connection
7	V <sub>B(V)</sub>	Bias Voltage for V-Phase High Side MOSFET Driving
8	V <sub>CC(V)</sub>	Bias Voltage for V-Phase IC and Low Side MOSFET Driving
9	IN <sub>(VH)</sub>	Signal Input for V-Phase High-Side
10	IN <sub>(VL)</sub>	Signal Input for V-Phase Low-Side
11	V <sub>TS</sub>	Output for HVIC Temperature Sensing
12	V <sub>B(W)</sub>	Bias Voltage for W-Phase High-Side MOSFET Driving
13	V <sub>CC(W)</sub>	Bias Voltage for W-Phase IC and Low-Side MOSFET Driving
14	IN <sub>(WH)</sub>	Signal Input for W-Phase High-Side
15	IN <sub>(WL)</sub>	Signal Input for W-Phase Low-Side
16	N.C	No Connection
17	Р	Positive DC-Link Input
18	U, V <sub>S(U)</sub>	Output for U-Phase & Bias Voltage Ground for High-Side MOSFET Driving
19	NU	Negative DC-Link Input for U-Phase
20	NV	Negative DC-Link Input for V-Phase
21	V, V <sub>S(V)</sub>	Output for V-Phase & Bias Voltage Ground for High-Side MOSFET Driving
22	N <sub>W</sub>	Negative DC-Link Input for W-Phase
23	W, V <sub>S(W)</sub>	Output for W Phase & Bias Voltage Ground for High-Side MOSFET Driving



#### 1st Notes:

3. Source terminal of each low-side MOSFET is not connected to supply ground or bias voltage ground inside Motion SPM<sup>®</sup> 5 product. External connections should be made as indicated in Figure 3.

## **Electrical Characteristics** ( $T_J$ = 25°C, $V_{CC}$ = $V_{BS}$ = 15 V unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
BV <sub>DSS</sub>	Drain - Source Breakdown Voltage	V <sub>IN</sub> = 0 V, I <sub>D</sub> = 1 mA (2nd Note 1)	500	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>IN</sub> = 0 V, V <sub>DS</sub> = 500 V	-	-	1	mA
R <sub>DS(on)</sub>	Static Drain - Source Turn-On Resistance	$V_{CC} = V_{BS} = 15 \text{ V}, V_{IN} = 5 \text{ V}, I_D = 1.2 \text{ A}$	-	1.0	1.4	Ω
V <sub>SD</sub>	Drain - Source Diode Forward Voltage	$V_{CC} = V_{BS} = 15V, V_{IN} = 0 V, I_D = -1.2 A$	-	-	1.2	V
t <sub>ON</sub>			-	600	-	ns
t <sub>OFF</sub>		$V_{PN} = 300 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}, I_D = 1.2 \text{ A}$	-	500	-	ns
t <sub>rr</sub>	Switching Times	$V_{IN} = 0 V \leftrightarrow 5 V$ , Inductive Load L = 3 mH High- and Low-Side MOSFET Switching	-	100	-	ns
E <sub>ON</sub>		(2nd Note 2)	-	60	-	μJ
E <sub>OFF</sub>			-	10	-	μJ
RBSOA	Reverse Bias Safe Oper- ating Area	$      V_{PN} = 400 \text{ V}, \text{ V}_{CC} = \text{V}_{BS} = 15 \text{ V}, \text{ I}_{D} = \text{I}_{DP}, \text{ V}_{DS} = \text{BV}_{DSS}, $ T_J = 150°C High- and Low-Side MOSFET Switching (2nd Note 3)		Full Square		

Inverter Part (each MOSFET unless otherwise specified.)

#### Control Part (each HVIC unless otherwise specified.)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IQCC	Quiescent V <sub>CC</sub> Current	V <sub>CC</sub> = 15 V, V <sub>IN</sub> = 0 V	Applied between V <sub>CC</sub> and COM	-	-	200	μΑ
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Current	V <sub>BS</sub> = 15 V, V <sub>IN</sub> = 0 V	Applied between V <sub>B(U)</sub> - U, V <sub>B(V)</sub> - V, V <sub>B(W)</sub> - W	-	-	100	μΑ
UV <sub>CCD</sub>	Low-Side Under-Voltage	V <sub>CC</sub> Under-Voltage Protection Detection Level		7.4	8.0	9.4	V
UV <sub>CCR</sub>	Protection (Figure 8)	V <sub>CC</sub> Under-Voltage Protection Reset Level		8.0	8.9	9.8	V
UV <sub>BSD</sub>	High-Side Under-Voltage	V <sub>BS</sub> Under-Voltage Protection Detection Level		7.4	8.0	9.4	V
UV <sub>BSR</sub>	Protection (Figure 9)	V <sub>BS</sub> Under-Voltage Protection Reset Level		8.0	8.9	9.8	V
V <sub>TS</sub>	HVIC Temperature Sens- ing Voltage Output	V <sub>CC</sub> = 15 V, T <sub>HVIC</sub> = 25°C (2nd Note 4)		600	790	980	mV
V <sub>IH</sub>	ON Threshold Voltage	Logic HIGH Level	Applied between V and COM	-	-	2.9	V
V <sub>IL</sub>	OFF Threshold Voltage	Logic LOW Level	Applied between V <sub>IN</sub> and COM	0.8	-	-	V

#### Bootstrap Diode Part (each bootstrap diode unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>FB</sub>	Forward Voltage	I <sub>F</sub> = 0.1 A, T <sub>C</sub> = 25°C (2nd Note 5)	-	2.5	-	V
t <sub>rrB</sub>	Reverse Recovery Time	I <sub>F</sub> = 0.1 A, T <sub>C</sub> = 25°C	-	80	-	ns

2nd Notes:

1. BV<sub>DSS</sub> is the absolute maximum voltage rating between drain and source terminal of each MOSFET inside Motion SPM<sup>®</sup> 5 product. V<sub>PN</sub> should be sufficiently less than this value considering the effect of the stray inductance so that  $V_{\text{PN}}$  should not exceed  $\text{BV}_{\text{DSS}}$  in any case.

2. t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay of the internal drive IC. Listed values are measured at the laboratory test condition, and they can be different according to the field applications due to the effect of different printed circuit boards and wirings. Please see Figure 6 for the switching time definition with the switching test circuit of Figure 7.

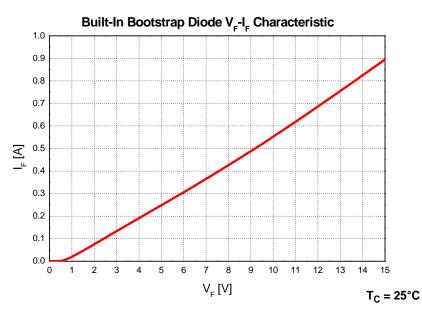
3. The peak current and voltage of each MOSFET during the switching operation should be included in the Safe Operating Area (SOA). Please see Figure 7 for the RBSOA test circuit that is same as the switching test circuit.

4.  $V_{ts}$  is only for sensing-temperature of module and cannot shutdown MOSFETs automatically.

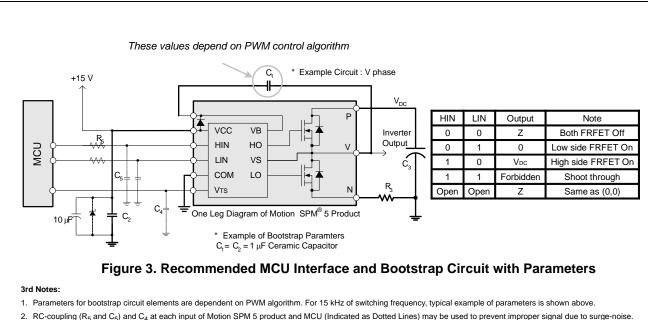
5. Built-in bootstrap diode includes around 15  $\,\Omega\, resistance$  characteristic. Please refer to Figure 2.

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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>PN</sub>	Supply Voltage	Applied between P and N	-	300	400	V
V <sub>CC</sub>	Control Supply Voltage	Applied between $V_{CC}$ and COM	13.5	15.0	16.5	V
V <sub>BS</sub>	High-Side Bias Voltage	Applied between $V_B$ and $V_S$	13.5	15.0	16.5	V
V <sub>IN(ON)</sub>	Input ON Threshold Voltage	Applied between V and COM	3.0	-	V <sub>CC</sub>	V
V <sub>IN(OFF)</sub>	Input OFF Threshold Voltage	Applied between V <sub>IN</sub> and COM	0	-	0.6	V
t <sub>dead</sub>	Blanking Time for Preventing Arm-Short	$V_{CC}$ = $V_{BS}$ = 13.5 ~ 16.5 V, $T_{J}~\leq 150^{\circ}C$	1	-	-	μS
f <sub>PWM</sub>	PWM Switching Frequency	$T_{J} \leq 150^{\circ}C$	-	15	-	kHz

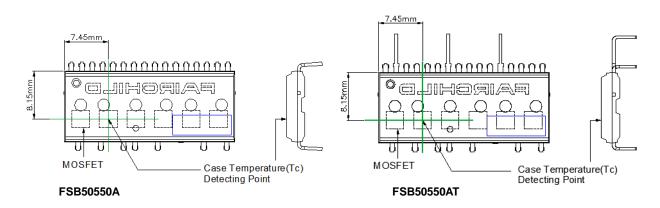






Bold lines should be short and thick in PCB pattern to have small stray inductance of circuit, which results in the reduction of surge-voltage. Bypass capacitors such as C1, C2 and C3 should have good high-frequency characteristics to absorb high-frequency ripple-current.

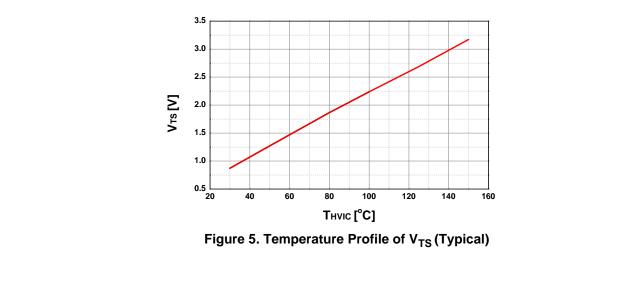




### Figure 4. Case Temperature Measurement

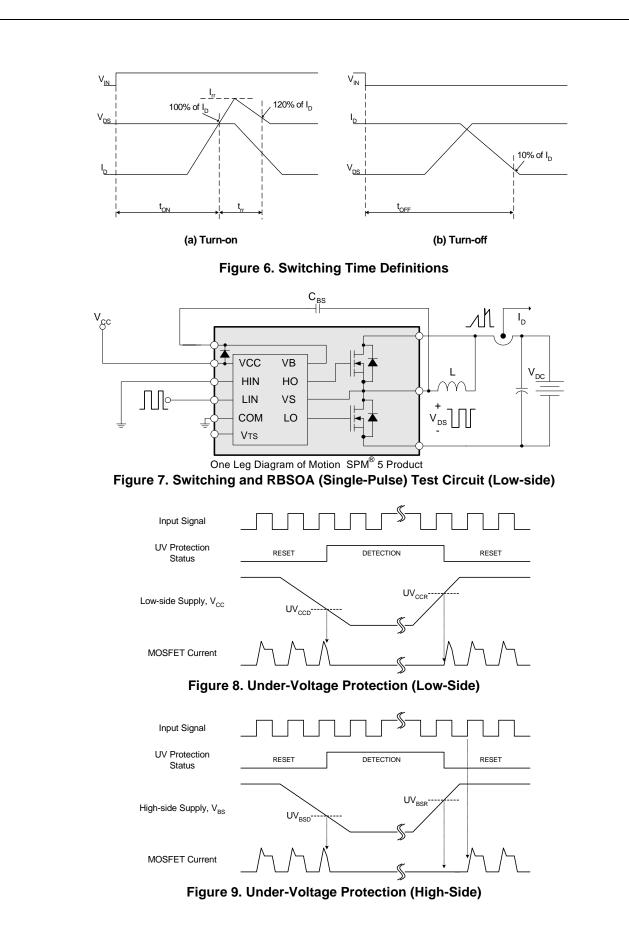
#### 3rd Notes:

4. Attach the thermocouple on top of the heat-sink of SPM 5 package (between SPM 5 package and heatsink if applied) to get the correct temperature measurement.



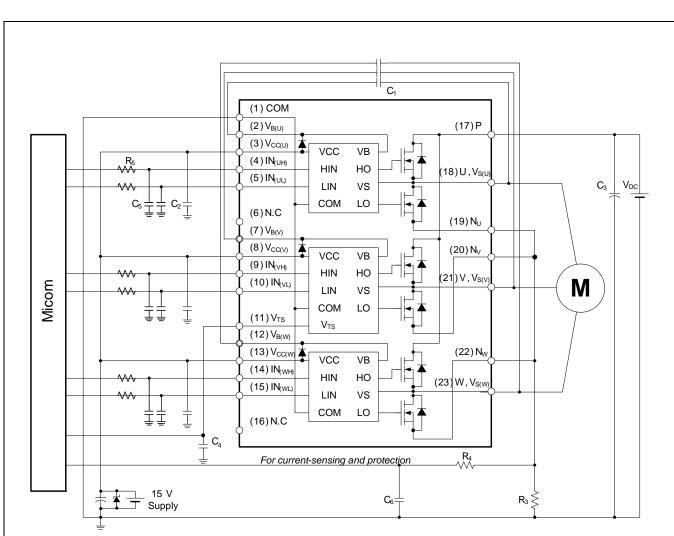
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## Figure 10. Example of Application Circuit

#### 4th Notes:

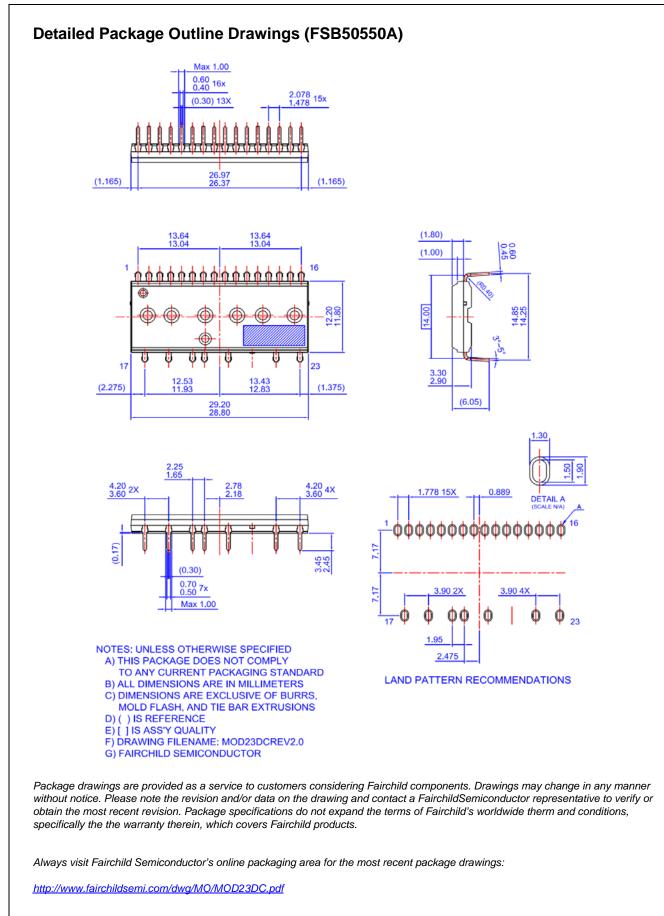
1. About pin position, refer to Figure 1.

2. RC-coupling (R<sub>5</sub> and C<sub>5</sub>, R<sub>4</sub> and C<sub>6</sub>) and C<sub>4</sub> at each input of Motion SPM<sup>®</sup> 5 product and MCU are useful to prevent improper input signal caused by surge-noise.

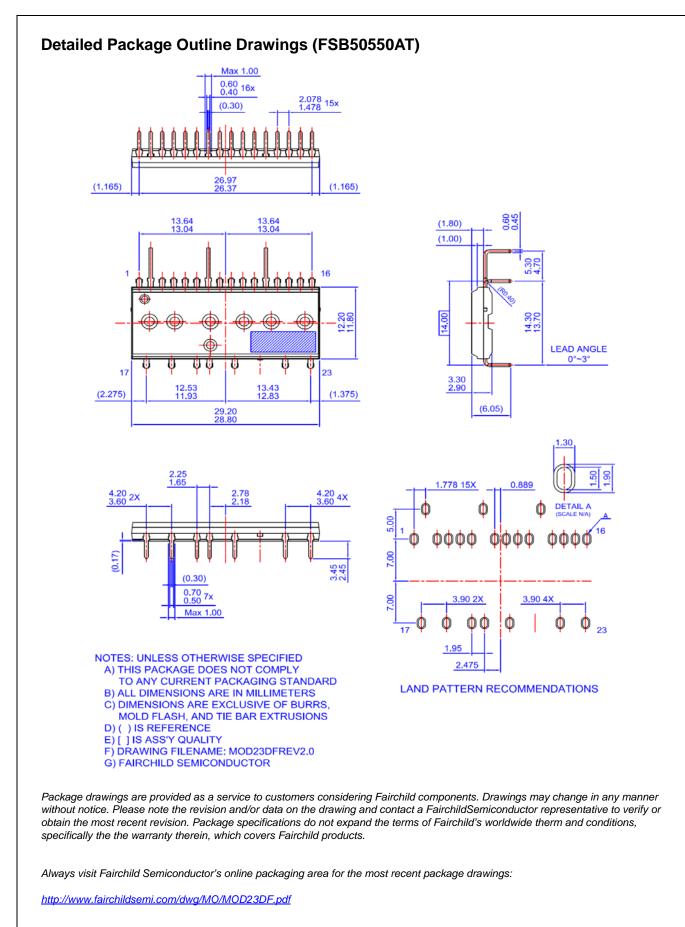
3. The voltage-drop across  $R_3$  affects the low-side switching performance and the bootstrap characteristics since it is placed between COM and the source terminal of the low-side MOSFET. For this reason, the voltage-drop across  $R_3$  should be less than 1 V in the steady-state.

4. Ground-wires and output terminals, should be thick and short in order to avoid surge-voltage and malfunction of HVIC.

5. All the filter capacitors should be connected close to Motion SPM 5 product, and they should have good characteristics for rejecting high-frequency ripple current.



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